

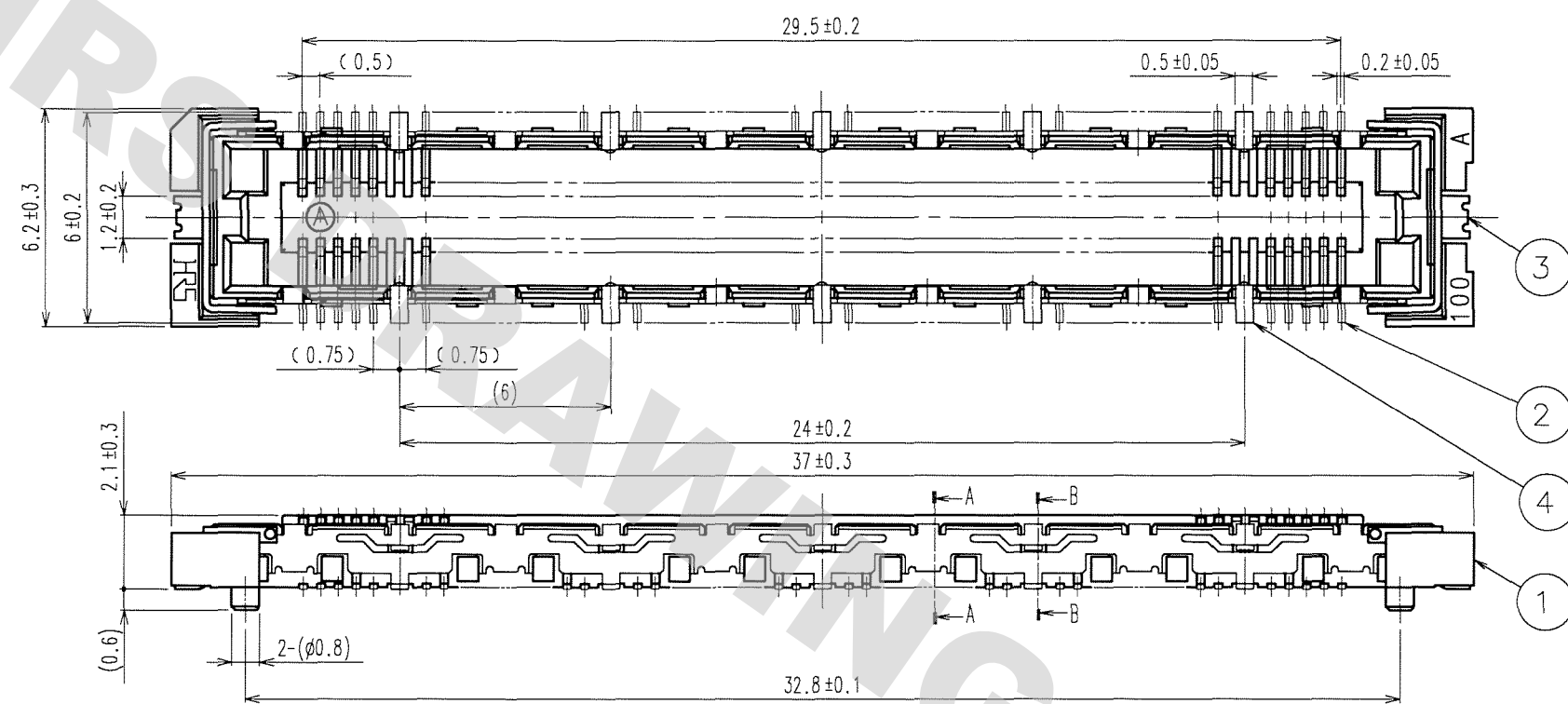
DRAWING FOR REFERENCE: This is subject to change without notice  
08/11/2012

TO  
PCK

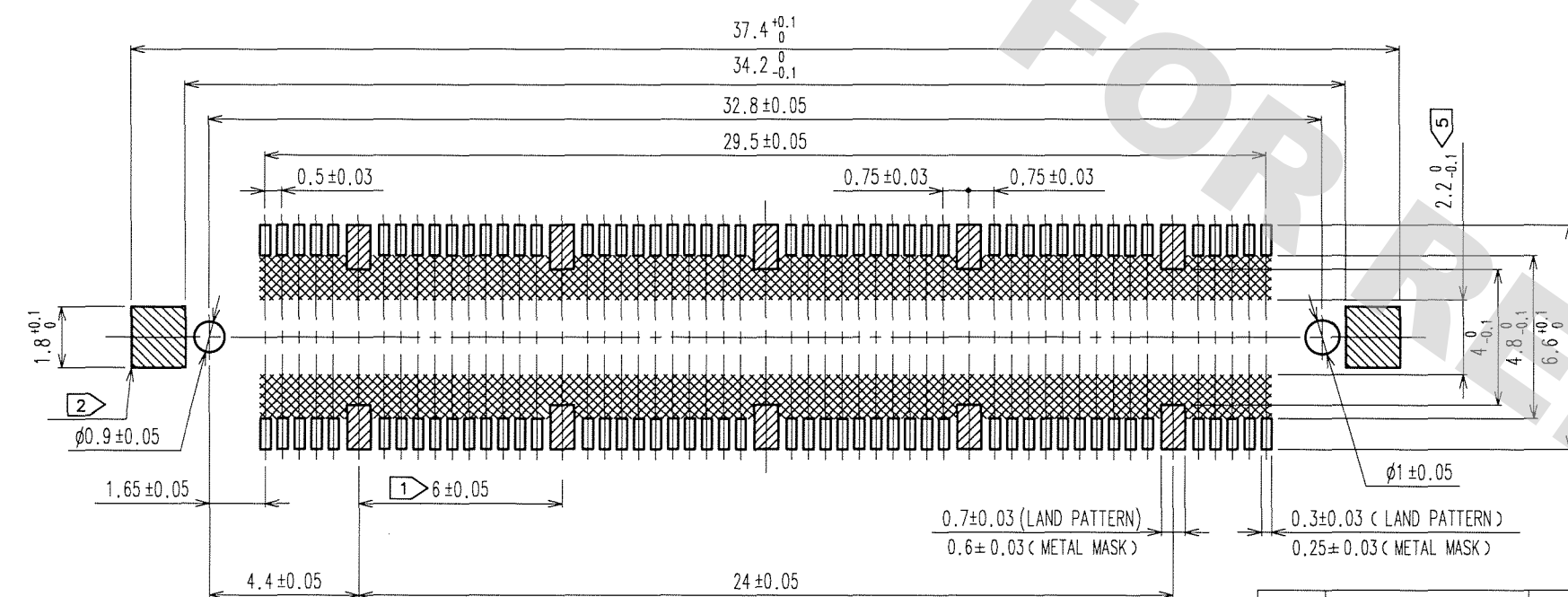
A  
B  
C  
D  
E  
F

1 2 3 4 5 6 7 8

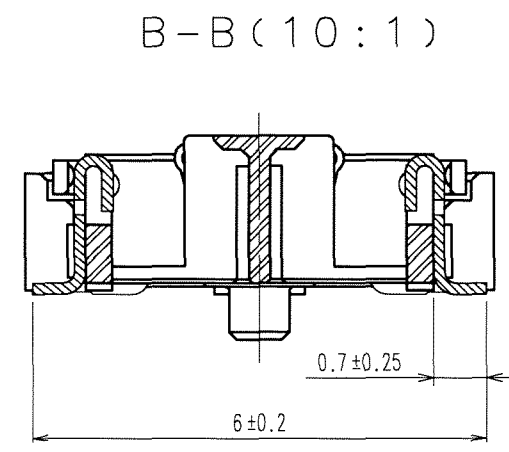
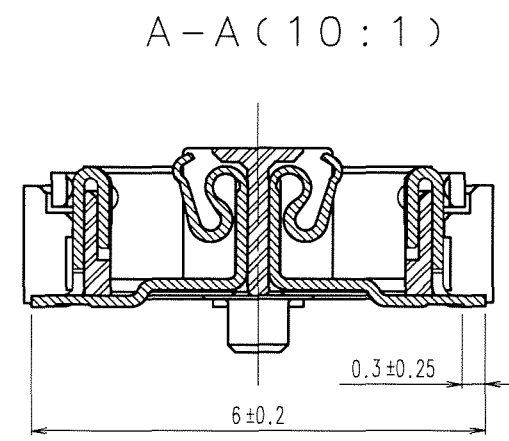
| COUNT | DESCRIPTION OF REVISIONS | BY | CHKD | DATE | COUNT | DESCRIPTION OF REVISIONS | BY | CHKD | DATE |
|-------|--------------------------|----|------|------|-------|--------------------------|----|------|------|
| △     |                          |    |      | ..   | △     |                          |    |      | ..   |
| △     |                          |    |      | ..   | △     |                          |    |      | ..   |
| △     |                          |    |      | ..   | △     |                          |    |      | ..   |



RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- ① 10 HATCHED PARTS: GROUND CIRCUIT.
  - ② 2 HATCHED PARTS: GROUND CIRCUIT.
  - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
  - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
  - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
  - ⑥ TO BE EMBOSSED CARRIER TAPED AS SPECIFIED IN SHEET 2.
  - ⑦ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.



|                      |                                  |                                  |                             |                      |                                 |
|----------------------|----------------------------------|----------------------------------|-----------------------------|----------------------|---------------------------------|
| 3. 4                 | PHOSPHOR BRONZE                  | TIN-PLATING                      | 2                           | PHOSPHOR BRONZE      | CONTACT AREA : GOLD 0.1μm min.  |
| 1                    | LCP                              | BEIGE UL94V-0                    |                             |                      | LEAD AREA : GOLD FLASH          |
| NO.                  | MATERIAL                         | FINISH, REMARKS                  | NO.                         | MATERIAL             | UNDER PLATING : NICKEL 1μm min. |
| FINISH, REMARKS      | FINISH, REMARKS                  | FINISH, REMARKS                  | FINISH, REMARKS             | FINISH, REMARKS      | FINISH, REMARKS                 |
| CODE NO. (OLD)<br>CL | DRAWN<br>A. SUZUKAWA             | DESIGNED<br>H. Nakamura          | CHECKED<br>H. Ogawa         | APPROVED<br>H. Okawa | RELEASED                        |
|                      | 06.11.01                         | 06.11.01                         | 06.11.01                    | 06.11.02             |                                 |
| SCALE<br>5 : 1       | DRAWING NO.<br>EDC3-152634-22    | PART NO.<br>FX11A-100S/10-SV(92) | CODE NO.<br>CL573-0704-4-92 | 1/2                  |                                 |
| UNITS<br>mm          | HR5<br>HIROSE ELECTRIC CO., LTD. |                                  |                             |                      |                                 |

1 2 3 4 5 6 7 8

DRAWING FOR REFERENCE: This is subject to change without notice  
08/11/2012

TO  
PCK

